

Description

The HXY20N02D uses advanced trench technology to provide excellent $R_{\text{DS}(\text{ON})}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications

General Features

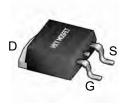
 $V_{DS} = 20V, I_D = 20A$ $R_{DS(ON)} < 25 \text{ m}\Omega @ V_{GS} = 4.5V$

High power and current handing capability Lead free product is acquired

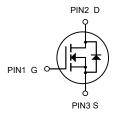
Surface mount package

Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply



TO252-2L



N-Channel MOSFET

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
HXY20N02D	TO252-2L	20N02 XXX YYYY	2500

Absolute Maximum Ratings@Tj=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	20	V
VGS	Gate-Source Voltage	<u>+</u> 12	V
I _D @T _C =25°C	Drain Current, V _{GS} @ 4.5V	20	Α
I _D @T _C =100°C	Drain Current, V _{GS} @ 4.5V	12	А
IDM	Pulsed Drain Current ¹	40	А
P _D @T _C =25°C	Total Power Dissipation	5	W
P _D @T _A =25°C	Total Power Dissipation ³	2	W
E _{AS}	Single Pulse Avalanche Energy ⁴	150	mJ
TSTG	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rthj-c	Maximum Thermal Resistance, Junction-case	5	°C/W
Rthj-a	Maximum Thermal Resistance, Junction-ambient ³	62	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20			V
\triangle BV _{DSS} / \triangle	BVDSS Temperature Coefficient	Reference to 25°C , I _D =1mA		0.023		V/°C
R _{DS(ON)}	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , b=8.0A		16	25	mΩ
	Static Drain-Source On-Resistance-	V _{GS} =2.5V , I _D =5.0A		22	30	
$V_{GS(th)}$	Gate Threshold Voltage	V _{GS} =V _{DS} . In =250uA	0.4	0.8	1.2	V
$\triangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	VGS-VDS , ID -250UA		-5.2		mV/°C
1	Drain Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =25°C			1	uA
· I _{DSS}	Drain-Source Leakage Current	V _{DS} =24V , V _{GS} =0V , T _J =55°C			5	uA
Igss	Gate-Source Leakage Current	V _{GS} =±20V , V _{DS} =0V			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =15A		21.6		S
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		2.5	5	Ω
Qg	Total Gate Charge (4.5V)			6.2	8.7	
Qgs	Gate-Source Charge	V _{DS} =15V , V _{GS} =4.5V , I _D =15A		2.4	3.4	nC
Q _{gd}	Gate-Drain Charge			2.5	3.5	
T _{d(on)}	Turn-On Delay Time			4	6.0	
Tr	Rise Time	V_{DD} =15V , V_{GS} =10V , R_{G} =3.3 Ω ,		7.6	14	
T _{d(off)}	Turn-Off Delay Time	I _D =15A		21	42	ns
T _f	Fall Time			4	8	
Ciss	Input Capacitance			472	801	
Coss	Output Capacitance	V _{DS} =15V , V _{GS} =0V , f=1MHz		71	113	pF
Crss	Reverse Transfer Capacitance			55	91	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,5}	\/-=\/-=0\/	-		20	Α
I _{SM}	Pulsed Source Current ^{2,5}	V _G =V _D =0V , Force Current			40	Α
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25°C			1.2	٧
t _{rr}	Reverse Recovery Time			17		nS
Qrr	Reverse Recovery Charge	lF=15A,dl/dt=100A/μs,Tյ=25°C	-	3		nC

Note:

- 1. The data tested by surface mounted on a 1 inch $^2\,\text{FR-4}$ board with 2OZ copper.
- 2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%
- 3. The EAS data shows Max. rating . The test condition is V_{DD} =25V, V_{GS} =10V,L=0.1mH, I_{AS} =21A
- 4.The power dissipation is limited by 150°C junction temperature
- 5. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.



Typical Characteristics

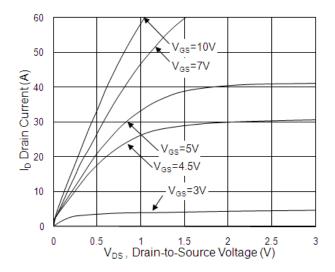


Fig.1 Typical Output Characteristics

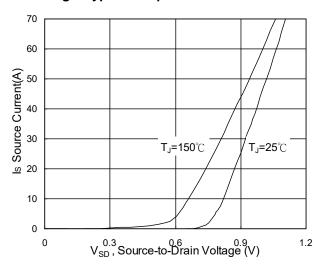


Fig.3 Forward Characteristics Of Reverse

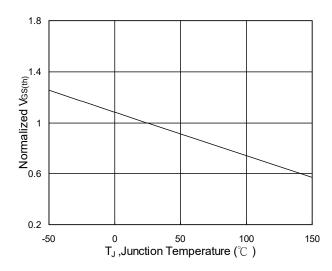


Fig.5 Normalized V_{GS(th)} v.s T_J

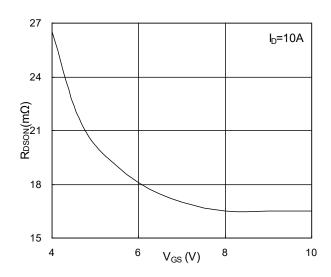


Fig.2 On-Resistance v.s Gate-Source

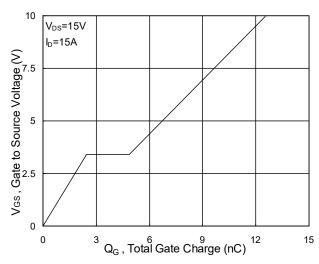


Fig.4 Gate-Charge Characteristics

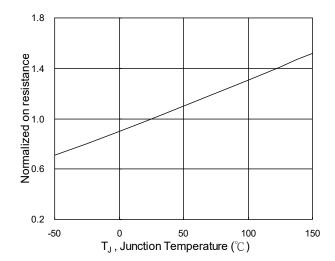
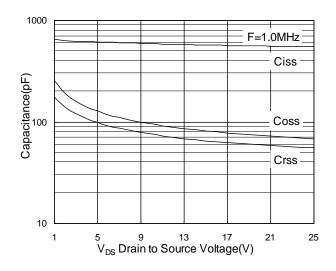


Fig.6 Normalized R_{DSON} v.s T_J



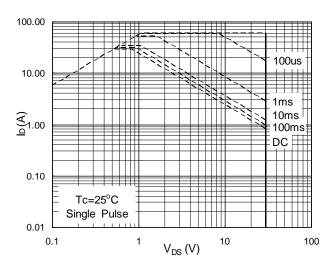


Fig.7 Capacitance

Fig.8 Safe Operating Area

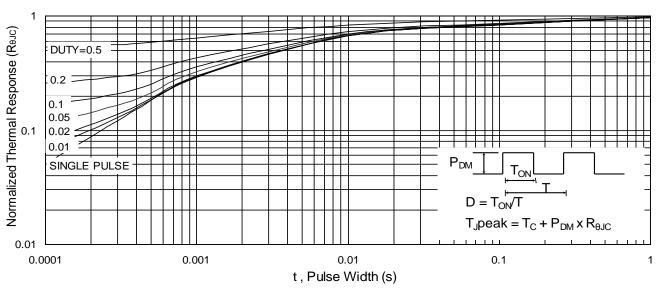


Fig.9 Normalized Maximum Transient Thermal Impedance

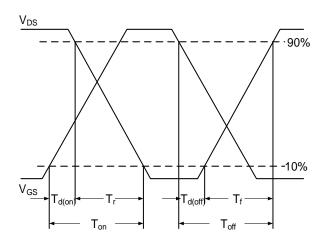


Fig.10 Switching Time Waveform

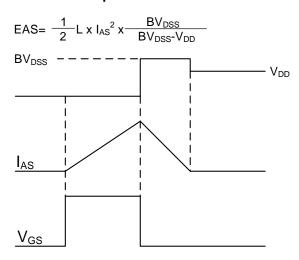
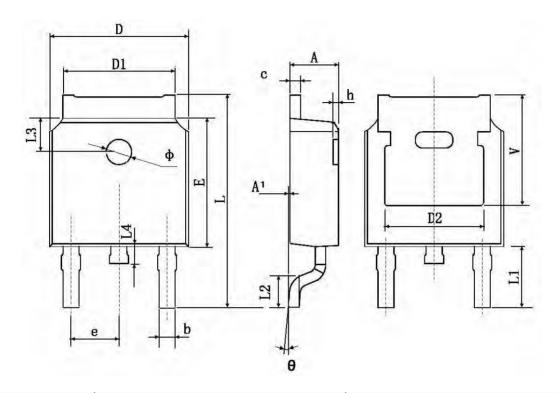


Fig.11 Unclamped Inductive Switching Waveform



TO252-2L Package Information



Cumbal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	2.200	2.400	0.087	0.094	
A1	0.000	0.127	0.000	0.005	
b	0.660	0.860	0.026	0.034	
С	0.460	0.580	0.018	0.023	
D	6.500	6.700	0.256	0.264	
D1	5.100	5.460	0.201	0.215	
D2	0.483 TYP.		0.190 TYP.		
E	6.000	6.200	0.236	0.244	
е	2.186	2.386	0.086	0.094	
L	9.800	10.400	0.386	0.409	
L1	2.900	TYP.	0.114	TYP.	
L2	1.400	1.700	0.055	0.067	
L3	1.600 TYP.		0.063 TYP.		
L4	0.600	1.000	0.024	0.039	
Ф	1.100	1.300	0.043	0.051	
θ	0°	8°	0°	8°	
h	0.000	0.300	0.000	0.012	
V	5.350	TYP.	0.211 TYP.		

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